PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chan Hee KANG	12/08/2009

RECEIVING PARTY DATA

Name:	Dongbu HiTek Co., Ltd.
Street Address:	891-10 Daechi-dong, Gangnam-gu
City:	Seoul
State/Country:	KOREA, REPUBLIC OF
Postal Code:	135-280

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12635008

CORRESPONDENCE DATA

Fax Number: (559)432-6872

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (559)432-6847

Email: info@fortneylaw.com

Correspondent Name: Andrew D. Fortney

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Address Line 4: FRESNO, CALIFORNIA 93711

ATTORNEY DOCKET NUMBER: SPO200909-0070US

NAME OF SUBMITTER: William E. Brow

Total Attachments: 1

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OF \$40.00 12635

PATENT REEL: 023634 FRAME: 0819 of Republic of Korea

RECORDED: 12/10/2009

, a corporation

, having a place of business

Attorney Docket No.: SPO200909-0070US

Do hereby sell, assign and transfer to Dongbu HiTek Co., Ltd.

at 891-10, Daechi-dong, Gangnam-gu, Seoul 135-280 / Republic of Korea

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

Chan Hee KANG

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

Lateral Double Diffused Metal Oxide Semiconductor Device

its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent

which may be granted therefor in the United States, its territorial possessions and all foreign countries and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof other applications for Letters Patent relating thereto which have been or shall be filed in the United St territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under the international conventions, unions, agreements, acts, and treaties, including all future conventions, agreements, acts, and treaties;	and all ates, its
Agree that Doughu HiTek Co., Ltd. apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to invention, in its own name, in the United States, its territorial possessions, and all foreign countries; as when requested to carry out in good faith the intent and purpose of this assignment, at the expense Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuationart, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assign powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating invention and the history thereof; and generally do everything possible which said Assignee, its successions, or legal representatives shall consider desirable for alding in securing, maintaining and enforcing patent protection for said invention and for vesting title to said invention and all applications for patents invention in said Assignee, its successors, assigns, or legal representatives; and	as said nd that, of said ions-in- uments, to said to said eessors,
Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersign IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicated below.	
Full Name of Sole/First Inventor:	
Chan Hee KANG	
Inventor's Signature: Date: Month/Day/Year Dec. / f (200)	ρ
Full Name of Second Inventor, if any:	
Inventor's Signature: Date: Month/Day/Year	
Customer No. 36872	

PATENT

REEL: 023634 FRAME: 0820